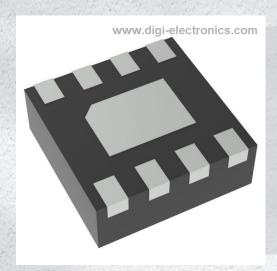


# MC100EP32MNR4G Datasheet



https://www.DiGi-Electronics.com

DiGi Electronics Part Number MC100EP32MNR4G-DG

Manufacturer onsemi

Manufacturer Product Number MC100EP32MNR4G

Description IC DIVIDER BY 2 1-BIT 8DFN

Detailed Description Counter IC Divide-by-2 1 Element 1 Bit Positive, Neg

ative 8-DFN (2x2)



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.



## **Purchase and inquiry**

| Manufacturer Product Number: | Manufacturer:               |
|------------------------------|-----------------------------|
| MC100EP32MNR4G               | onsemi                      |
| Series:                      | Product Status:             |
| 100EP                        | Active                      |
| Logic Type:                  | Direction:                  |
| Divide-by-2                  |                             |
| Number of Elements:          | Number of Bits per Element: |
| 1                            | 1                           |
| Reset:                       | Timing:                     |
| Asynchronous                 |                             |
| Count Rate:                  | Trigger Type:               |
| 4 GHz                        | Positive, Negative          |
| Voltage - Supply:            | Operating Temperature:      |
| 3 V ~ 5.5 V                  | -40°C ~ 85°C                |
| Mounting Type:               | Package / Case:             |
| Surface Mount                | 8-VFDFN Exposed Pad         |
| Supplier Device Package:     | Base Product Number:        |
| 8-DFN (2x2)                  | 100EP32                     |

## **Environmental & Export classification**

8542.39.0001

| RoHS Status:     | Moisture Sensitivity Level (MSL): |
|------------------|-----------------------------------|
| ROHS3 Compliant  | 1 (Unlimited)                     |
| REACH Status:    | ECCN:                             |
| REACH Unaffected | EAR99                             |
| HTSUS:           |                                   |



www.onsemi.com

## 3.3 V/5 V ECL ÷2 Divider MC10EP32, MC100EP32

#### **Description**

The MC10/100EP32 is an integrated  $\div 2$  divider with differential

The V<sub>BB</sub> pin, an internally generated voltage supply, is available to this device only. For single-ended input conditions, the unused differential input is connected to V<sub>BB</sub> as a switching reference voltage. V<sub>BB</sub> may also rebias AC coupled inputs. When used, decouple V<sub>BB</sub> and  $V_{CC}$  via a 0.01  $\mu F$  capacitor and limit current sourcing or sinking to 0.5 mA. When not used,  $V_{BB}$  should be left open.

The reset pin is asynchronous and is asserted on the rising edge. Upon power-up, the internal flip-flops will attain a random state; the reset allows for the synchronization of multiple EP32's in a system.

The 100 Series contains temperature compensation.

#### **Features**

- 350 ps Typical Propagation Delay
- Maximum Frequency > 4 GHz Typical (Figure 3)
- PECL Mode Operating Range:
  - $V_{CC} = 3.0 \text{ V}$  to 5.5 V with  $V_{EE} = 0 \text{ V}$
- NECL Mode Operating Range:
  - $V_{CC} = 0 \text{ V}$  with  $V_{EE} = -3.0 \text{ V}$  to -5.5 V
- Open Input Default State
- Safety Clamp on Inputs
- Q Output Will Default LOW with Inputs Open or at V<sub>EE</sub>
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant





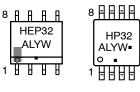


SOIC-8 NB **D SUFFIX** 

TSSOP-8 **DT SUFFIX** CASE 751-07 CASE 948R-02

**MN SUFFIX** CASE 506AA

#### **MARKING DIAGRAMS\***









= Assembly Location

= MC10 Κ = MC100 = MC100 3K = Date Code \٨/

= Wafer Lot = Year = Work Week = Pb-Free Package

(Note: Microdot may be in either location)

\*For additional marking information, refer to Application Note AND8002/D.

#### ORDERING INFORMATION

See detailed ordering and shipping information on page 8 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 8.

1

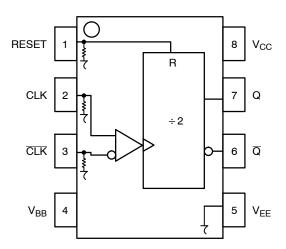


Figure 1. 8-Lead Pinout (Top View) and Logic Diagram

**Table 1. PIN DESCRIPTION** 

| Pin             | Function  |
|-----------------|---|
| CLK, CLK*       | ECL Clock Inputs  |
| Reset*          | ECL Asynchronous Reset  |
| V <sub>BB</sub> | Reference Voltage Output  |
| Q, Q            | ECL Data Outputs  |
| V <sub>CC</sub> | Positive Supply   |
| V <sub>EE</sub> | Negative Supply   |
| EP              | (DFN-8 only) Thermal exposed pad must be connected to a sufficient thermal conduit. Electrically connect to the most negative supply (GND) or leave unconnected, floating open. |

<sup>\*</sup>Pins will default LOW when left open.

Table 2. TRUTH TABLE

| CLK | CLK | RESET | Q | Q |
|-----|-----|-------|---|---|
| X   | X   | Z     | L | H |
| Z   | Z   | L     | F | F |

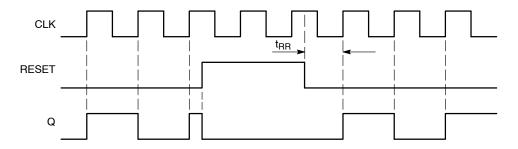


Figure 2. Timing Diagram

#### **Table 3. ATTRIBUTES**

| Characteristics  | Value                         |
|--|-------------------------------|
| Internal Input Pulldown Resistor                                   | 75 kΩ                         |
| Internal Input Pullup Resistor                                     | N/A                           |
| ESD Protection Human Body Model Machine Model Charged Device Model | > 4 kV<br>> 200 V<br>> 2 kV   |
| Moisture Sensitivity, Indefinite Time Out of Drypack (Note 1)      | Pb-Free Pkg                   |
| SOIC-8 NB<br>TSSOP-8<br>DFN-8                                      | Level 1<br>Level 3<br>Level 1 |
| Flammability Rating Oxygen Index: 28 to 34                         | UL 94 V-0 @ 0.125 in          |
| Transistor Count   | 78 Devices                    |
| Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test             | •                             |

<sup>1.</sup> For additional information, see Application Note AND8003/D.

 $<sup>\</sup>overline{Z}$  = LOW to HIGH Transition  $\overline{Z}$  = HIGH to LOW Transition F = Divide by 2 Function

**Table 4. MAXIMUM RATINGS** 

| Symbol            | Parameter  | Condition 1                                    | Condition 2                                | Rating      | Unit |
|-------------------|--|--|--|-------------|------|
| V <sub>CC</sub>   | PECL Mode Power Supply                             | V <sub>EE</sub> = 0 V                          |  | 6           | V    |
| V <sub>EE</sub>   | NECL Mode Power Supply                             | V <sub>CC</sub> = 0 V                          |  | -6          | V    |
| VI                | PECL Mode Input Voltage<br>NECL Mode Input Voltage | V <sub>EE</sub> = 0 V<br>V <sub>CC</sub> = 0 V | $V_{I} \leq V_{CC}$<br>$V_{I} \geq V_{EE}$ | 6<br>-6     | ٧    |
| l <sub>out</sub>  | Output Current                                     | Continuous<br>Surge                            |  | 50<br>100   | mA   |
| I <sub>BB</sub>   | V <sub>BB</sub> Sink/Source                        |  |  | ±0.5        | mA   |
| T <sub>A</sub>    | Operating Temperature Range                        |  |  | -40 to +85  | °C   |
| T <sub>stg</sub>  | Storage Temperature Range                          |  |  | -65 to +150 | °C   |
| $\theta_{\sf JA}$ | Thermal Resistance (Junction-to-Ambient)           | 0 lfpm<br>500 lfpm                             | SOIC-8 NB                                  | 190<br>130  | °C/W |
| $\theta_{\sf JC}$ | Thermal Resistance (Junction-to-Case)              | Standard Board                                 | SOIC-8 NB                                  | 41 to 44    | °C/W |
| $\theta_{\sf JA}$ | Thermal Resistance (Junction-to-Ambient)           | 0 lfpm<br>500 lfpm                             | TSSOP-8                                    | 185<br>140  | °C/W |
| $\theta_{\sf JC}$ | Thermal Resistance (Junction-to-Case)              | Standard Board                                 | TSSOP-8                                    | 41 to 44    | °C/W |
| $\theta_{\sf JA}$ | Thermal Resistance (Junction-to-Ambient)           | 0 lfpm<br>500 lfpm                             | DFN8                                       | 129<br>84   | °C/W |
| θЈС               | Thermal Resistance (Junction-to-Case)              | (Note 1)                                       | DFN8                                       | 35 to 40    | °C/W |
| T <sub>sol</sub>  | Wave Solder (Pb-Free)                              | <2 to 3 sec @ 260°C                            |  | 265         | °C   |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Table 5. 10EP DC CHARACTERISTICS, PECL ( $V_{CC} = 3.3 \text{ V}$ ,  $V_{EE} = 0 \text{ V}$  (Note 1))

|                    |   | -40°C |      |      | 25°C |      |      |      |      |      |      |
|--------------------|---|-------|------|------|------|------|------|------|------|------|------|
| Symbol             | Characteristic  | Min   | Тур  | Max  | Min  | Тур  | Max  | Min  | Тур  | Max  | Unit |
| I <sub>EE</sub>    | Power Supply Current  | 23    | 30   | 40   | 23   | 30   | 40   | 23   | 30   | 40   | mA   |
| V <sub>OH</sub>    | Output HIGH Voltage (Note 2)  | 2165  | 2290 | 2415 | 2230 | 2355 | 2480 | 2290 | 2415 | 2540 | mV   |
| V <sub>OL</sub>    | Output LOW Voltage (Note 2)   | 1365  | 1490 | 1615 | 1430 | 1555 | 1680 | 1490 | 1615 | 1740 | mV   |
| V <sub>IH</sub>    | Input HIGH Voltage (Single-Ended)   | 2090  |      | 2415 | 2155 |      | 2480 | 2215 |      | 2540 | mV   |
| V <sub>IL</sub>    | Input LOW Voltage (Single-Ended)  | 1365  |      | 1690 | 1430 |      | 1755 | 1490 |      | 1815 | mV   |
| V <sub>BB</sub>    | Output Voltage Reference  | 1790  | 1890 | 1990 | 1855 | 1955 | 2055 | 1915 | 2015 | 2115 | mV   |
| V <sub>IHCMR</sub> | Input HIGH Voltage Common Mode<br>Range (Differential Configuration) (Note 3) | 2.0   |      | 3.3  | 2.0  |      | 3.3  | 2.0  |      | 3.3  | V    |
| I <sub>IH</sub>    | Input HIGH Current  |       |      | 150  |      |      | 150  |      |      | 150  | μΑ   |
| I <sub>IL</sub>    | Input LOW Current   | 0.5   |      |      | 0.5  |      |      | 0.5  |      |      | μΑ   |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.

- Input and output parameters vary 1:1 with V<sub>CC</sub>. V<sub>EE</sub> can vary +0.3 V to -2.2 V.
   All loading with 50 Ω to V<sub>CC</sub> 2.0 V.
   V<sub>IHCMR</sub> min varies 1:1 with V<sub>EE</sub>, V<sub>IHCMR</sub> max varies 1:1 with V<sub>CC</sub>. The V<sub>IHCMR</sub> range is referenced to the most positive side of the differential input signal.

<sup>1.</sup> JEDEC standard multilayer board - 2S2P (2 signal, 2 power)

Table 6. 10EP DC CHARACTERISTICS, PECL (V<sub>CC</sub> = 5.0 V, V<sub>EE</sub> = 0 V (Note 1))

|                    |  | −40°C |      |      | 25°C |      |      | 85°C |      |      |      |
|--------------------|--|-------|------|------|------|------|------|------|------|------|------|
| Symbol             | Characteristic   | Min   | Тур  | Max  | Min  | Тур  | Max  | Min  | Тур  | Max  | Unit |
| I <sub>EE</sub>    | Power Supply Current   | 23    | 30   | 40   | 23   | 30   | 40   | 23   | 30   | 40   | mA   |
| V <sub>OH</sub>    | Output HIGH Voltage (Note 2)   | 3865  | 3990 | 4115 | 3930 | 4055 | 4180 | 3990 | 4115 | 4240 | mV   |
| V <sub>OL</sub>    | Output LOW Voltage (Note 2)  | 3065  | 3190 | 3315 | 3130 | 3255 | 3380 | 3190 | 3315 | 3440 | mV   |
| V <sub>IH</sub>    | Input HIGH Voltage (Single-Ended)  | 3790  |      | 4115 | 3855 |      | 4180 | 3915 |      | 4240 | mV   |
| V <sub>IL</sub>    | Input LOW Voltage (Single-Ended)   | 3065  |      | 3390 | 3130 |      | 3455 | 3190 |      | 3515 | mV   |
| V <sub>BB</sub>    | Output Voltage Reference   | 3490  | 3590 | 3690 | 3555 | 3655 | 3755 | 3615 | 3715 | 3815 | mV   |
| V <sub>IHCMR</sub> | Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 3) | 2.0   |      | 5.0  | 2.0  |      | 5.0  | 2.0  |      | 5.0  | ٧    |
| I <sub>IH</sub>    | Input HIGH Current   |       |      | 150  |      |      | 150  |      |      | 150  | μΑ   |
| I <sub>IL</sub>    | Input LOW Current  | 0.5   |      |      | 0.5  |      |      | 0.5  |      |      | μΑ   |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.

- 1. Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{EE}$  can vary +2.0 V to -0.5 V.
- 2. All loading with 50  $\Omega$  to  $V_{CC}$  2.0 V.
- V<sub>IHCMR</sub> min varies 1:1 with V<sub>EE</sub>, V<sub>IHCMR</sub> max varies 1:1 with V<sub>CC</sub>. The V<sub>IHCMR</sub> range is referenced to the most positive side of the differential input signal.

Table 7. 10EP DC CHARACTERISTICS, NECL ( $V_{CC}$  = 0 V;  $V_{EE}$  = -5.5 V to -3.0 V (Note 1))

|                    |  |                      | −40°C |       |                 | 25°C  |       |       |                      |       |      |
|--------------------|--|----------------------|-------|-------|-----------------|-------|-------|-------|----------------------|-------|------|
| Symbol             | Characteristic   | Min                  | Тур   | Max   | Min             | Тур   | Max   | Min   | Тур                  | Max   | Unit |
| I <sub>EE</sub>    | Power Supply Current   | 23                   | 30    | 40    | 23              | 30    | 40    | 23    | 30                   | 40    | mA   |
| V <sub>OH</sub>    | Output HIGH Voltage (Note 2)   | -1135                | -1010 | -885  | -1070           | -945  | -820  | -1010 | -885                 | -760  | mV   |
| V <sub>OL</sub>    | Output LOW Voltage (Note 2)  | -1935                | -1810 | -1685 | -1870           | -1745 | -1620 | -1810 | -1685                | -1560 | mV   |
| V <sub>IH</sub>    | Input HIGH Voltage (Single-Ended)  | -1210                |       | -885  | -1145           |       | -820  | -1085 |                      | -760  | mV   |
| $V_{IL}$           | Input LOW Voltage (Single-Ended)   | -1935                |       | -1610 | -1870           |       | -1545 | -1810 |                      | -1485 | mV   |
| $V_{BB}$           | Output Voltage Reference   | -1510                | -1410 | -1310 | -1445           | -1345 | -1245 | -1385 | -1285                | -1185 | mV   |
| V <sub>IHCMR</sub> | Input HIGH Voltage Common Mode<br>Range (Differential Configuration)<br>(Note 3) | V <sub>EE</sub> +2.0 |       | 0.0   | V <sub>EE</sub> | +2.0  | 0.0   |       | V <sub>EE</sub> +2.0 |       | V    |
| I <sub>IH</sub>    | Input HIGH Current   |                      |       | 150   |                 |       | 150   |       |                      | 150   | μΑ   |
| I <sub>IL</sub>    | Input LOW Current  | 0.5                  |       |       | 0.5             |       |       | 0.5   |                      |       | μΑ   |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.

- 1. Input and output parameters vary 1:1 with V<sub>CC</sub>.
- 2. All loading with 50  $\Omega$  to  $V_{CC}$  2.0 V.
- V<sub>IHCMR</sub> min varies 1:1 with V<sub>EE</sub>, V<sub>IHCMR</sub> max varies 1:1 with V<sub>CC</sub>. The V<sub>IHCMR</sub> range is referenced to the most positive side of the differential input signal.

Table 8. 100EP DC CHARACTERISTICS, PECL (V<sub>CC</sub> = 3.3 V, V<sub>EE</sub> = 0 V (Note 1))

|                    |   | -40°C |      |      | 25°C |      |      | 85°C |      |      |      |
|--------------------|---|-------|------|------|------|------|------|------|------|------|------|
| Symbol             | Characteristic  | Min   | Тур  | Max  | Min  | Тур  | Max  | Min  | Тур  | Max  | Unit |
| I <sub>EE</sub>    | Power Supply Current  | 23    | 30   | 37   | 26   | 34   | 40   | 28   | 36   | 42   | mA   |
| V <sub>OH</sub>    | Output HIGH Voltage (Note 2)  | 2155  | 2280 | 2405 | 2155 | 2280 | 2405 | 2155 | 2280 | 2405 | mV   |
| V <sub>OL</sub>    | Output LOW Voltage (Note 2)   | 1355  | 1480 | 1605 | 1355 | 1480 | 1605 | 1355 | 1480 | 1605 | mV   |
| $V_{IH}$           | Input HIGH Voltage (Single-Ended)   | 2075  |      | 2420 | 2075 |      | 2420 | 2075 |      | 2420 | mV   |
| $V_{IL}$           | Input LOW Voltage (Single-Ended)  | 1355  |      | 1675 | 1355 |      | 1675 | 1355 |      | 1675 | mV   |
| V <sub>BB</sub>    | Output Voltage Reference  | 1775  | 1875 | 1975 | 1775 | 1875 | 1975 | 1775 | 1875 | 1975 | mV   |
| V <sub>IHCMR</sub> | Input HIGH Voltage Common Mode Range<br>(Differential Configuration) (Note 3) | 2.0   |      | 3.3  | 2.0  |      | 3.3  | 2.0  |      | 3.3  | ٧    |
| I <sub>IH</sub>    | Input HIGH Current  |       |      | 150  |      |      | 150  |      |      | 150  | μΑ   |
| I <sub>IL</sub>    | Input LOW Current   | 0.5   |      |      | 0.5  |      |      | 0.5  |      |      | μΑ   |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.

- 1. Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{EE}$  can vary +0.3 V to -2.2 V.
- 2. All loading with 50  $\Omega$  to  $V_{CC}$  2.0 V.
- 3. VIHCMR min varies 1:1 with VEE, VIHCMR max varies 1:1 with VCC. The VIHCMR range is referenced to the most positive side of the differential input signal.

Table 9. 100EP DC CHARACTERISTICS, PECL ( $V_{CC} = 5.0 \text{ V}$ ,  $V_{EE} = 0 \text{ V}$  (Note 1))

|                    |  | -40°C |      |      | 25°C |      |      | 85°C |      |      |      |
|--------------------|--|-------|------|------|------|------|------|------|------|------|------|
| Symbol             | Characteristic   | Min   | Тур  | Max  | Min  | Тур  | Max  | Min  | Тур  | Max  | Unit |
| I <sub>EE</sub>    | Power Supply Current   | 23    | 30   | 37   | 26   | 34   | 40   | 28   | 36   | 42   | mA   |
| V <sub>OH</sub>    | Output HIGH Voltage (Note 2)   | 3855  | 3980 | 4105 | 3855 | 3980 | 4105 | 3855 | 3980 | 4105 | mV   |
| V <sub>OL</sub>    | Output LOW Voltage (Note 2)  | 3055  | 3180 | 3305 | 3055 | 3180 | 3305 | 3055 | 3180 | 3305 | mV   |
| V <sub>IH</sub>    | Input HIGH Voltage (Single-Ended)  | 3775  |      | 4120 | 3775 |      | 4120 | 3775 |      | 4120 | mV   |
| $V_{IL}$           | Input LOW Voltage (Single-Ended)   | 3055  |      | 3375 | 3055 |      | 3375 | 3055 |      | 3375 | mV   |
| V <sub>BB</sub>    | Output Voltage Reference   | 3475  | 3575 | 3675 | 3475 | 3575 | 3675 | 3475 | 3575 | 3675 | mV   |
| V <sub>IHCMR</sub> | Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 3) | 2.0   |      | 5.0  | 2.0  |      | 5.0  | 2.0  |      | 5.0  | V    |
| I <sub>IH</sub>    | Input HIGH Current   |       |      | 150  |      |      | 150  |      |      | 150  | μΑ   |
| I <sub>IL</sub>    | Input LOW Current  | 0.5   |      |      | 0.5  |      |      | 0.5  |      |      | μА   |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.

- 1. Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{EE}$  can vary +2.0 V to -0.5 V.
- All loading with 50 Ω to V<sub>CC</sub> 2.0 V.
   V<sub>IHCMR</sub> min varies 1:1 with V<sub>EE</sub>, V<sub>IHCMR</sub> max varies 1:1 with V<sub>CC</sub>. The V<sub>IHCMR</sub> range is referenced to the most positive side of the differential input signal.

Table 10. 100EP DC CHARACTERISTICS, NECL ( $V_{CC} = 0 \text{ V}$ ;  $V_{EE} = -5.5 \text{ V}$  to -3.0 V (Note 1))

|                    |  |                      | -40°C |       | 25°C                 |       |       |                      |       |       |      |
|--------------------|--|----------------------|-------|-------|----------------------|-------|-------|----------------------|-------|-------|------|
| Symbol             | Characteristic   | Min                  | Тур   | Max   | Min                  | Тур   | Max   | Min                  | Тур   | Max   | Unit |
| I <sub>EE</sub>    | Power Supply Current   | 23                   | 30    | 37    | 26                   | 34    | 40    | 28                   | 36    | 42    | mA   |
| V <sub>OH</sub>    | Output HIGH Voltage (Note 2)   | -1145                | -1020 | -895  | -1145                | -1020 | -895  | -1145                | -1020 | -895  | mV   |
| V <sub>OL</sub>    | Output LOW Voltage (Note 2)  | -1945                | -1820 | -1695 | -1945                | -1820 | -1695 | -1945                | -1820 | -1695 | mV   |
| V <sub>IH</sub>    | Input HIGH Voltage (Single-Ended)  | -1225                |       | -880  | -1225                |       | -880  | -1225                |       | -880  | mV   |
| V <sub>IL</sub>    | Input LOW Voltage (Single-Ended)   | -1945                |       | -1625 | -1945                |       | -1625 | -1945                |       | -1625 | mV   |
| V <sub>BB</sub>    | Output Voltage Reference   | -1525                | -1425 | -1325 | -1525                | -1425 | -1325 | -1525                | -1425 | -1325 | mV   |
| V <sub>IHCMR</sub> | Input HIGH Voltage Common Mode<br>Range (Differential Configuration)<br>(Note 3) | V <sub>EE</sub> +2.0 |       | 0.0   | V <sub>EE</sub> +2.0 |       | 0.0   | V <sub>EE</sub> +2.0 |       | 0.0   | V    |
| I <sub>IH</sub>    | Input HIGH Current   |                      |       | 150   |                      |       | 150   |                      |       | 150   | μΑ   |
| I <sub>IL</sub>    | Input LOW Current  | 0.5                  |       |       | 0.5                  |       |       | 0.5                  |       |       | μΑ   |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.

- 1. Input and output parameters vary 1:1 with V<sub>CC</sub>.
- 2. All loading with 50  $\Omega$  to  $V_{CC}$  2.0 V.
- V<sub>IHCMR</sub> min varies 1:1 with V<sub>EE</sub>, V<sub>IHCMR</sub> max varies 1:1 with V<sub>CC</sub>. The V<sub>IHCMR</sub> range is referenced to the most positive side of the differential input signal.

 $\textbf{Table 11. AC CHARACTERISTICS} \ (V_{CC} = 0 \ V; \ V_{EE} = -3.0 \ V \ to \ -5.5 \ V \ or \ V_{CC} = 3.0 \ V \ to \ 5.5 \ V; \ V_{EE} = 0 \ V \ (Note \ 1))$ 

|  |   |                   | -40°C             |                   |                   | 25°C              |                   |                   | 85°C              |                   |      |
|--|---|-------------------|-------------------|-------------------|-------------------|-------------------|-------------------|-------------------|-------------------|-------------------|------|
| Symbol                                 | Characteristic  | Min               | Тур               | Max               | Min               | Тур               | Max               | Min               | Тур               | Max               | Unit |
| V <sub>OPP</sub>                       | Output Voltage Amplitude (See Figure 3) $f_{in} < 3.5 \text{ GHz}$ $f_{in} @ 4.0 \text{ GHz}$         | 640               | 700<br>740        |                   | 630               | 700<br>710        |                   | 500               | 700<br>600        |                   | mV   |
| t <sub>PLH</sub> ,<br>t <sub>PHL</sub> | Propagation Delay to Output Differential CLK to Q, Q 10 Series RESET to Q, Q 100 Series RESET to Q, Q | 250<br>220<br>320 | 330<br>290<br>400 | 420<br>390<br>480 | 270<br>250<br>320 | 350<br>300<br>400 | 450<br>390<br>480 | 320<br>320<br>375 | 400<br>380<br>450 | 480<br>460<br>525 | ps   |
| t <sub>RR</sub>                        | Set/Reset Recovery  | 200               | 175               |                   | 200               | 175               |                   | 200               | 175               |                   | ps   |
| t <sub>PW</sub>                        | Minimum Pulse width<br>RESET  | 550               | 475               |                   | 550               | 475               |                   | 550               | 475               |                   | ps   |
| t <sub>JITTER</sub>                    | CLOCK Random Jitter (RMS) $f_{in} < 3.5 \text{ GHz}$ $f_{in} @ \leq 4.0 \text{ GHz}$                  |                   | 0.5<br>0.5        | 1.5               |                   | 0.5<br>0.5        | 1.5               |                   | 0.5<br>0.5        | 1.5               | ps   |
| V <sub>PP</sub>                        | Input Voltage Swing<br>(Differential Configuration)   | 150               | 800               | 1200              | 150               | 800               | 1200              | 150               | 800               | 1200              | mV   |
| t <sub>r</sub><br>t <sub>f</sub>       | Output Rise/Fall Times<br>Q, Q (20% – 80%)  | 50                | 100               | 150               | 70                | 120               | 170               | 70                | 130               | 200               | ps   |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.

1. Measured using a 750 mV source, 50% duty cycle clock source. All loading with 50  $\Omega$  to  $V_{CC}$  – 2.0 V.

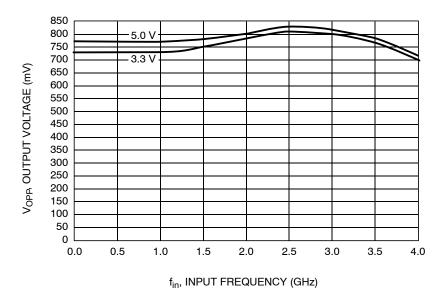


Figure 3. Input Frequency (fin) Versus Typical Output Voltage (VOPP)

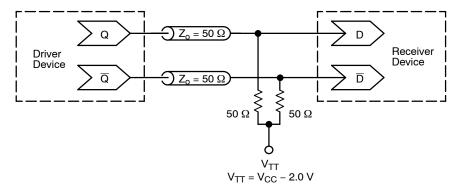


Figure 4. Typical Termination for Output Driver and Device Evaluation (See Application Note <u>AND8020/D</u> – Termination of ECL Logic Devices.)

#### **ORDERING INFORMATION**

| Device         | Package                | Shipping <sup>†</sup> |
|----------------|------------------------|-----------------------|
| MC10EP32DR2G   | SOIC-8 NB<br>(Pb-Free) | 2500 / Tape & Reel    |
| MC10EP32DTG    | TSSOP-8<br>(Pb-Free)   | 100 Units / Tube      |
| MC10EP32DTR2G  | TSSOP-8<br>(Pb-Free)   | 2500 / Tape & Reel    |
| MC100EP32DG    | SOIC-8 NB<br>(Pb-Free) | 98 Units / Tube       |
| MC100EP32DR2G  | SOIC-8 NB<br>(Pb-Free) | 2500 / Tape & Reel    |
| MC100EP32DTG   | TSSOP-8<br>(Pb-Free)   | 100 Units / Tube      |
| MC100EP32DTR2G | TSSOP-8<br>(Pb-Free)   | 2500 / Tape & Reel    |
| MC100EP32MNR4G | DFN-8<br>(Pb-Free)     | 1000 / Tape & Reel    |

#### **DISCONTINUED** (Note 2)

| MC10EP32DG | SOIC-8 NB | 98 Units / Tube |
|------------|-----------|-----------------|
|            | (Pb-Free) |                 |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <a href="https://example.com/BRD8011/D">BRD8011/D</a>.

#### **Resource Reference of Application Notes**

AN1405/D - ECL Clock Distribution Techniques

AN1406/D - Designing with PECL (ECL at +5.0 V)

AN1503/D - ECLinPS™ I/O SPiCE Modeling Kit

AN1504/D - Metastability and the ECLinPS Family

AN1568/D - Interfacing Between LVDS and ECL

AN1672/D - The ECL Translator Guide

AND8001/D - Odd Number Counters Design

AND8002/D - Marking and Date Codes

AND8020/D - Termination of ECL Logic Devices

AND8066/D - Interfacing with ECLinPS

AND8090/D - AC Characteristics of ECL Devices

ECLinPS is a trademark of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries.

<sup>2.</sup> **DISCONTINUED:** This device is not recommended for new design. Please contact your **onsemi** representative for information. The most current information on this device may be available on <a href="https://www.onsemi.com">www.onsemi.com</a>.



## **MECHANICAL CASE OUTLINE**

DIMENSIONING AND TOLERANCING PER

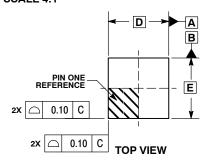
ASME Y14.5M, 1994.
CONTROLLING DIMENSION: MILLIMETERS. DIMENSION 6 APPLIES TO PLATED
TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.20 MM FROM TERMINAL TIP. COPLANARITY APPLIES TO THE EXPOSED

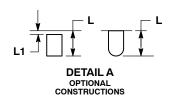
**PACKAGE DIMENSIONS** 

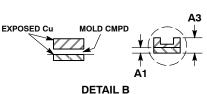


#### DFN8 2x2, 0.5P CASE 506AA ISSUE F

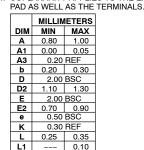
**DATE 04 MAY 2016** 







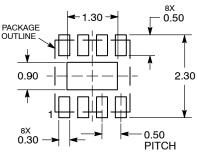
ALTERNATE CONSTRUCTIONS



NOTES

0.10 С DETAIL B 0.08 С (A3) NOTE 4 SEATING PLANE C SIDE VIEW

**RECOMMENDED** SOLDERING FOOTPRINT\*



DIMENSIONS: MILLIMETERS

**DETAIL A** +D2 → 0.10 CAB Ф е С 0.05 NOTE 3 **BOTTOM VIEW** 

#### **GENERIC MARKING DIAGRAM\***



XX = Specific Device Code

= Date Code

= Pb-Free Device

\*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

| DOCUMENT NUMBER: | 98AON18658D                | Electronic versions are uncontrolled except when accessed directly from the Document Rep<br>Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. |             |  |
|------------------|----------------------------|---|-------------|--|
| DESCRIPTION:     | DFN8, 2.0X2.0, 0.5MM PITCH |   | PAGE 1 OF 1 |  |

onsemi and ONSEMi, are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. **onsemi** makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

<sup>\*</sup>This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



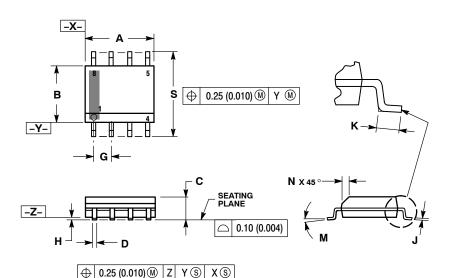
## **MECHANICAL CASE OUTLINE**

PACKAGE DIMENSIONS



SOIC-8 NB CASE 751-07 **ISSUE AK** 

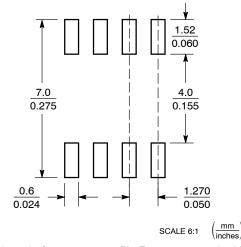
**DATE 16 FEB 2011** 



- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  CONTROLLING DIMENSION: MILLIMETER.
- DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
- MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE
- DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
- 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

|     | MILLIMETERS |       | INCHES |       |  |
|-----|-------------|-------|--------|-------|--|
| DIM | MIN         | MAX   | MIN    | MAX   |  |
| Α   | 4.80        | 5.00  | 0.189  | 0.197 |  |
| В   | 3.80        | 4.00  | 0.150  | 0.157 |  |
| С   | 1.35        | 1.75  | 0.053  | 0.069 |  |
| D   | 0.33        | 0.51  | 0.013  | 0.020 |  |
| G   | 1.27        | 7 BSC | 0.05   | 0 BSC |  |
| Н   | 0.10        | 0.25  | 0.004  | 0.010 |  |
| J   | 0.19        | 0.25  | 0.007  | 0.010 |  |
| K   | 0.40        | 1.27  | 0.016  | 0.050 |  |
| М   | 0 °         | 8 °   | 0 °    | 8 °   |  |
| N   | 0.25        | 0.50  | 0.010  | 0.020 |  |
| S   | 5.80        | 6.20  | 0.228  | 0.244 |  |

#### **SOLDERING FOOTPRINT\***



<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

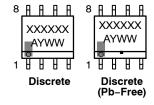
#### **GENERIC MARKING DIAGRAM\***



XXXXX = Specific Device Code = Assembly Location = Wafer Lot

= Year = Work Week

= Pb-Free Package



XXXXXX = Specific Device Code = Assembly Location Α

ww = Work Week

= Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

#### **STYLES ON PAGE 2**

| DOCUMENT NUMBER: | 98ASB42564B | Electronic versions are uncontrolled except when accessed directly from the Document Repositor<br>Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. |             |  |  |
|------------------|-------------|---|-------------|--|--|
| DESCRIPTION:     | SOIC-8 NB   |   | PAGE 1 OF 2 |  |  |

onsemi and ONSEMi, are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

#### SOIC-8 NB CASE 751-07 ISSUE AK

#### **DATE 16 FEB 2011**

| STYLE 1: PIN 1. EMITTER 2. COLLECTOR 3. COLLECTOR 4. EMITTER 5. EMITTER 6. BASE 7. BASE 8. EMITTER   | STYLE 2: PIN 1. COLLECTOR, DIE, #1 2. COLLECTOR, #1 3. COLLECTOR, #2 4. COLLECTOR, #2 5. BASE, #2 6. EMITTER, #2 7. BASE, #1 8. EMITTER, #1 | STYLE 3: PIN 1. DRAIN, DIE #1 2. DRAIN, #1 3. DRAIN, #2 4. DRAIN, #2 5. GATE, #2 6. SOURCE, #2 7. GATE, #1 8. SOURCE, #1   | STYLE 4: PIN 1. ANODE 2. ANODE 3. ANODE 4. ANODE 5. ANODE 6. ANODE 7. ANODE 8. COMMON CATHODE  |
|--|---|--|--|
| STYLE 5: PIN 1. DRAIN 2. DRAIN 3. DRAIN 4. DRAIN 5. GATE 6. GATE 7. SOURCE 8. SOURCE   | STYLE 6: PIN 1. SOURCE 2. DRAIN 3. DRAIN 4. SOURCE 5. SOURCE 6. GATE 7. GATE 8. SOURCE  | PIN 1. INPUT  2. EXTERNAL BYPASS  3. THIRD STAGE SOURCE  4. GROUND  5. DRAIN  6. GATE 3  7. SECOND STAGE Vd  8. FIRST STAGE Vd   | PIN 1. COLLECTOR, DIE #1 2. BASE, #1   |
| STYLE 9: PIN 1. EMITTER, COMMON 2. COLLECTOR, DIE #1 3. COLLECTOR, DIE #2 4. EMITTER, COMMON 5. EMITTER, COMMON 6. BASE, DIE #2 7. BASE, DIE #1 8. EMITTER, COMMON       | STYLE 10: PIN 1. GROUND 2. BIAS 1 3. OUTPUT 4. GROUND 5. GROUND 6. BIAS 2 7. INPUT 8. GROUND  | STYLE 11: PIN 1. SOURCE 1 2. GATE 1 3. SOURCE 2 4. GATE 2 5. DRAIN 2 6. DRAIN 2 7. DRAIN 1   | STYLE 12: PIN 1. SOURCE 2. SOURCE 3. SOURCE 4. GATE 5. DRAIN 6. DRAIN 7. DRAIN 9. DRAIN  |
| STYLE 13: PIN 1. N.C. 2. SOURCE 3. SOURCE 4. GATE 5. DRAIN 6. DRAIN 7. DRAIN 8. DRAIN  | STYLE 14: PIN 1. N-SOURCE 2. N-GATE 3. P-SOURCE 4. P-GATE 5. P-DRAIN 6. P-DRAIN 7. N-DRAIN 8. N-DRAIN                                       | STYLE 15: PIN 1. ANODE 1 2. ANODE 1 3. ANODE 1 4. ANODE 1 5. CATHODE, COMMON 6. CATHODE, COMMON 7. CATHODE, COMMON 8. CATHODE, COMMON  | STYLE 16:  PIN 1. EMITTER, DIE #1 2. BASE, DIE #1 3. EMITTER, DIE #2 4. BASE, DIE #2 5. COLLECTOR, DIE #2 6. COLLECTOR, DIE #2 7. COLLECTOR, DIE #1 8. COLLECTOR, DIE #1 |
| STYLE 17: PIN 1. VCC 2. V2OUT 3. V1OUT 4. TXE 5. RXE 6. VEE 7. GND 8. ACC  | STYLE 18:<br>PIN 1. ANODE<br>2. ANODE   | STYLE 19: PIN 1. SOURCE 1 2. GATE 1 3. SOURCE 2 4. GATE 2 5. DRAIN 2 6. MIRROR 2   | STYLE 20: PIN 1. SOURCE (N) 2. GATE (N) 3. SOURCE (P) 4. GATE (P) 5. DRAIN 6. DRAIN  |
| 3. V10UT 4. TXE 5. RXE 6. VEE 7. GND 8. ACC  STYLE 21: PIN 1. CATHODE 1 2. CATHODE 2 3. CATHODE 3 4. CATHODE 4 5. CATHODE 5 6. COMMON ANODE 7. COMMON ANODE 8. CATHODE 6 | STYLE 22:   | 7. DRAIN 1 8. MIRROR 1 8. TYLE 23: PIN 1. LINE 1 IN 2. COMMON ANODE/GND 3. COMMON ANODE/GND 4. LINE 2 IN 5. LINE 2 OUT 6. COMMON ANODE/GND 7. COMMON ANODE/GND 8. LINE 1 OUT | STYLE 24: PIN 1. BASE 2. EMITTER 3. COLLECTOR/ANODE 4. COLLECTOR/ANODE 5. CATHODE 6. CATHODE 7. COLLECTOR/ANODE 8. COLLECTOR/ANODE                                       |
| STYLE 25: PIN 1. VIN 2. N/C 3. REXT 4. GND 5. IOUT 6. IOUT 7. IOUT 8. IOUT   | STYLE 26: PIN 1. GND 2. dv/dt 3. ENABLE 4. ILIMIT 5. SOURCE 6. SOURCE 7. SOURCE 8. VCC  | STYLE 27: PIN 1. ILIMIT 2. OVLO 3. UVLO 4. INPUT+ 5. SOURCE 6. SOURCE 7. SOURCE 8. DRAIN   | STYLE 28: PIN 1. SW_TO_GND 2. DASIC_OFF 3. DASIC_SW_DET 4. GND 5. V_MON 6. VBULK 7. VBULK 8. VIN   |
| STYLE 29: PIN 1. BASE, DIE #1 2. EMITTER, #1 3. BASE, #2 4. EMITTER, #2 5. COLLECTOR, #2 6. COLLECTOR, #2 7. COLLECTOR, #1 8. COLLECTOR, #1                              | STYLE 30: PIN 1. DRAIN 1 2. DRAIN 1 3. GATE 2 4. SOURCE 2 5. SOURCE 1/DRAIN 2 6. SOURCE 1/DRAIN 2 7. SOURCE 1/DRAIN 2 8. GATE 1             |  |  |

| DOCUMENT NUMBER: | 98ASB42564B | Electronic versions are uncontrolled except when accessed directly from the Document Report Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. |             |  |  |
|------------------|-------------|---|-------------|--|--|
| DESCRIPTION:     | SOIC-8 NB   |   | PAGE 2 OF 2 |  |  |

onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.



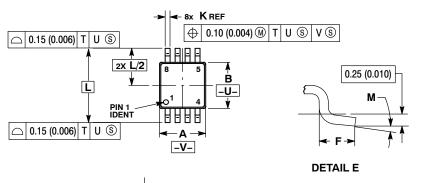
## **MECHANICAL CASE OUTLINE**

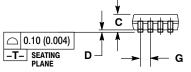
PACKAGE DIMENSIONS

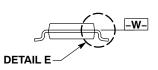


#### TSSOP-8 3.00x3.00x0.95 CASE 948R-02 **ISSUE A**

**DATE 07 APR 2000** 







#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
   CONTROLLING DIMENSION: MILLIMETER.
- DIMENSION A DOES NOT INCLUDE MOLD FLASH.
   DIMENSION OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
- DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
- TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
- 6. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

|     | MILLIMETERS |          | INCHES |       |  |
|-----|-------------|----------|--------|-------|--|
| DIM | MIN         | MAX      | MIN    | MAX   |  |
| Α   | 2.90        | 3.10     | 0.114  | 0.122 |  |
| В   | 2.90        | 3.10     | 0.114  | 0.122 |  |
| С   | 0.80        | 1.10     | 0.031  | 0.043 |  |
| D   | 0.05        | 0.15     | 0.002  | 0.006 |  |
| F   | 0.40        | 0.70     | 0.016  | 0.028 |  |
| G   | 0.65        | 0.65 BSC |        | BSC   |  |
| K   | 0.25        | 0.40     | 0.010  | 0.016 |  |
| L   | 4.90        | BSC      | 0.193  | BSC   |  |
| M   | 0°          | 6 °      | 0°     | 6°    |  |

| DOCUMENT NUMBER: | 98AON00236D            | Electronic versions are uncontrolled except when accessed directly from the Document Rep<br>Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. |             |  |
|------------------|------------------------|---|-------------|--|
| DESCRIPTION:     | TSSOP-8 3.00x3.00x0.95 |   | PAGE 1 OF 1 |  |

onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves brisefin and of 160 m are trademarked so defined values of services and of the confined values and of the values of the confined values and of the values of the confined values and of the values of the special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <a href="www.onsemi.com/site/pdf/Patent-Marking.pdf">www.onsemi.com/site/pdf/Patent-Marking.pdf</a>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that onsemi was negligent regarding the design or manufacture of the part. onsemi is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

 $\textbf{Technical Library:} \ \underline{www.onsemi.com/design/resources/technical-documentation}$ 

onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at

www.onsemi.com/support/sales



### **OUR CERTIFICATE**

DiGi provide top-quality products and perfect service for customer worldwide through standardization, technological innovation and continuous improvement. DiGi through third-party certification, we striciy control the quality of products and services. Welcome your RFQ to Email: Info@DiGi-Electronics.com

















Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com